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FCP11N60F N-Channel SuperFET[®] FRFET[®] MOSFET 600 V, 11 A, 380 m Ω

Features

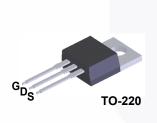
- 650 V @T_J = 150°C
- Typ. R_{DS(on)} = 320 mΩ
- Fast Recovery Type (t_{rr} = 120 ns)
- Ultra Low Gate Charge (Typ. Q_g = 40 nC)
- Low Effective Output Capacitance (Typ. C_{oss}.eff = 95 pF)
- 100% Avalanche Tested
- RoHS compliant

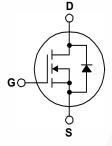
Application

- LCD/LED/PDP TV
- Lighting
- Solar Inverter
- AC-DC Power Supply

Description

SuperFET[®] MOSFET is Fairchild Semiconductor's first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low onresistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SuperFET MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. Super-FET FRFET[®] MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter Drain to Source Voltage			FCP11N60F	Unit V	
V _{DSS}				600		
I _D	Drain Current	- Continuous (T _C = 25 ^o C)		11		
		- Continuous (T _C = 100 ^o C)		7	— A	
DM	Drain Current	- Pulsed	(Note 1)	33	Α	
/ _{GSS}	Gate to Source Voltage			±30	V	
AS	Single Pulsed Avalanche	Energy	(Note 2)	340	mJ	
AR	Avalanche Current		(Note 1)	11	Α	
AR	Repetitive Avalanche Ene	ergy	(Note 1)	12.5	mJ	
dv/dt	Peak Diode Recovery dv/	dt	(Note 3)	4.5	V/ns	
P _D	Power Dissipation	(T _C = 25°C)		125	W	
		- Derate above 25ºC		1.0	W/ºC	
Г _Ј , Т _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
ΓL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

Symbol	Parameter	FCP11N60F	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max	1.0	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max	62.5	°C/W

November 2013

Device MarkingDeviceFCP11N60FFCP11N60F		Device	Package	Package Reel		Tape Width	Qua	antity
		FCP11N60F	TO-220 -		-	-	50	
Electric	al Characte	eristics T _C = 25°C un	less otherwise noted.					
Symbol		Parameter	Test Cond	litions	Min.	Тур.	Max.	Unit
Off Charact	teristics				1			
	Drain to Source Breakdown Voltage		$V_{GS} = 0 V, I_D = 250 \mu A, T_C = 25^{\circ}C$ $V_{GS} = 0 V, I_D = 250 \mu A, T_C = 150^{\circ}C$			-	-	V
BV _{DSS}						650	-	V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient		$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-	0.6	-	V/ºC
BV _{DS}	Drain-Source Avalanche Breakdown Voltage		V _{GS} = 0 V, I _D = 11 A		-	700	-	V
	Zero Gate Voltage Drain Current		V _{DS} = 600 V, V _{GS} = 0 V		-	-	1	μA
IDSS	Zero Gale volta	ige Drain Current	V _{DS} = 480 V, T _C = 125 ^o C			-	10	
I _{GSS}	Gate to Body L	eakage Current	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$		-	-	±100	nA
On Charact	teristics		·					
V _{GS(th)}	Gate Threshold	Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$		3.0	-	5.0	V
R _{DS(on)}	Static Drain to S	Source On Resistance	V _{GS} = 10 V, I _D = 5.5 A		-	0.32	0.38	Ω
9 _{FS}	Forward Transo	conductance	V _{DS} = 40 V, I _D = 5.5 A		-	6	-	S
Dynamic C	haracteristics							
C _{iss}	Input Capacitar	ice	V _{DS} = 25 V, V _{GS} = 0 V f = 1.0 MHz		-	1148	1490	pF
C _{oss}	Output Capacita	ance			-	671	870	pF
C _{rss}	Reverse Transf	er Capacitance	1 - 1.0 10112		-	63	82	pF
C _{oss}	Output Capacita	ance	V _{DS} = 480 V, V _{GS} =	0 V, f = 1.0 MH	z -	35	-	pF
C _{oss} eff.	Effective Outpu	t Capacitance	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$		-	95	-	pF
Switching (Characteristics					i		
t _{d(on)}	Turn-On Delay	Time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 11 \text{ A}$ R _G = 25 Ω		-	34	80	ns
t _r	Turn-On Rise T	ime			-	98	205	ns
t _{d(off)}	Turn-Off Delay	Time			-	119	250	ns
t _f	Turn-Off Fall Ti	me		(Note -	4) -	56	120	ns
Q _{g(tot)}	Total Gate Cha	rge at 10V	V _{DS} = 480 V, I _D = 1 ⁴	1 A	-	40	52	nC
Q _{gs}	Gate to Source	Gate Charge	$V_{GS} = 10 V$ (Note 4)		-	7.2	-	nC
Q _{qd}	Gate to Drain "I	Viller" Charge			4) _	21	-	nC
Ū.	ce Diode Charac	teristics Maximum Rati	ngs			I		
I _S	Maximum Continuous Drain to Source Diode Forward Current			-	-	11	Α	
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	-	33	Α	
V _{SD}	Drain to Source	Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 11	A	-	-	1.4	V
t _{rr}	Reverse Recov		V _{GS} = 0 V, I _{SD} = 11		-	120	-	ns
Q _{rr}	Reverse Recov	erv Charge	$dI_{F}/dt = 100 A/\mu s$		-	0.8		μC

Notes:

1. Repetitive Rating : Pulse width limited by maximum junction temperature.

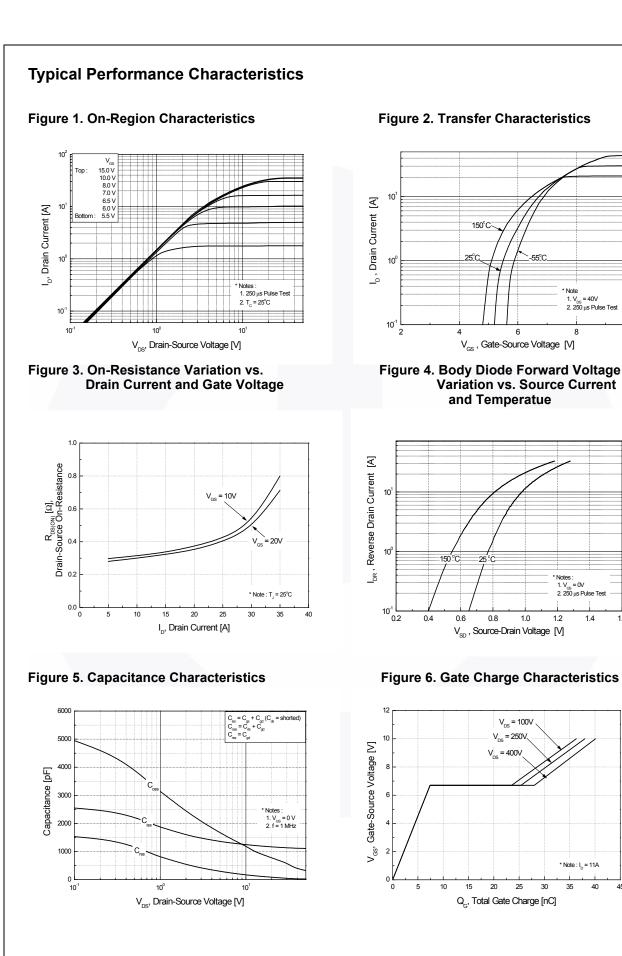
2. I_{AS} = 5.5 A, V_{DD} = 50 V, R_G = 25 Ω , Starting T_J = 25°C.

3. I_{SD} \leq 11 A, di/dt \leq 200 A/µs, V_{DD} \leq BV_{DSS,} starting ~T_J = 25°C.

4. Essentially independent of operating temperature.

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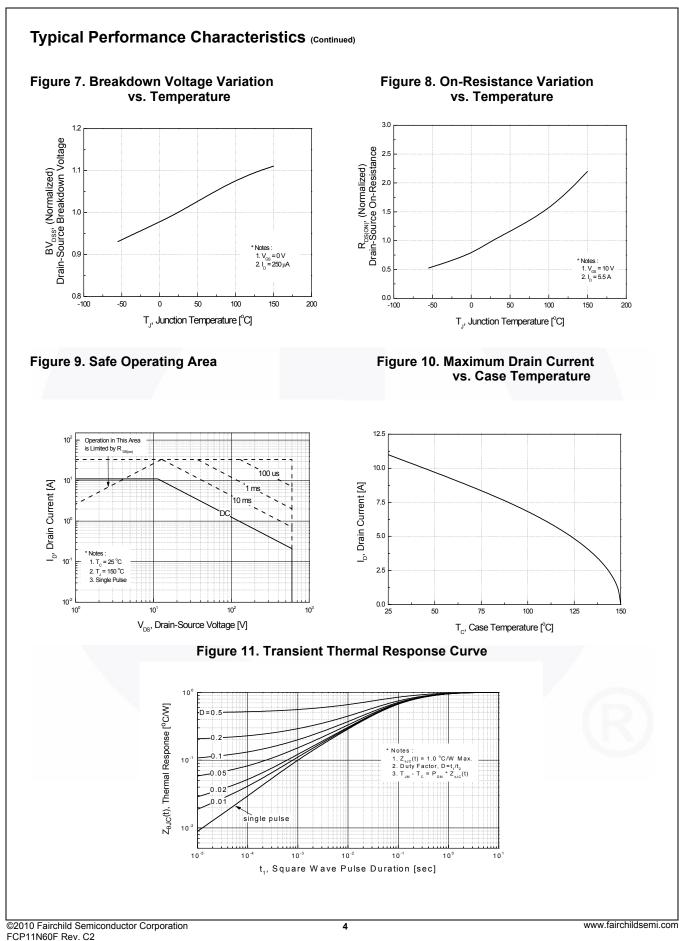
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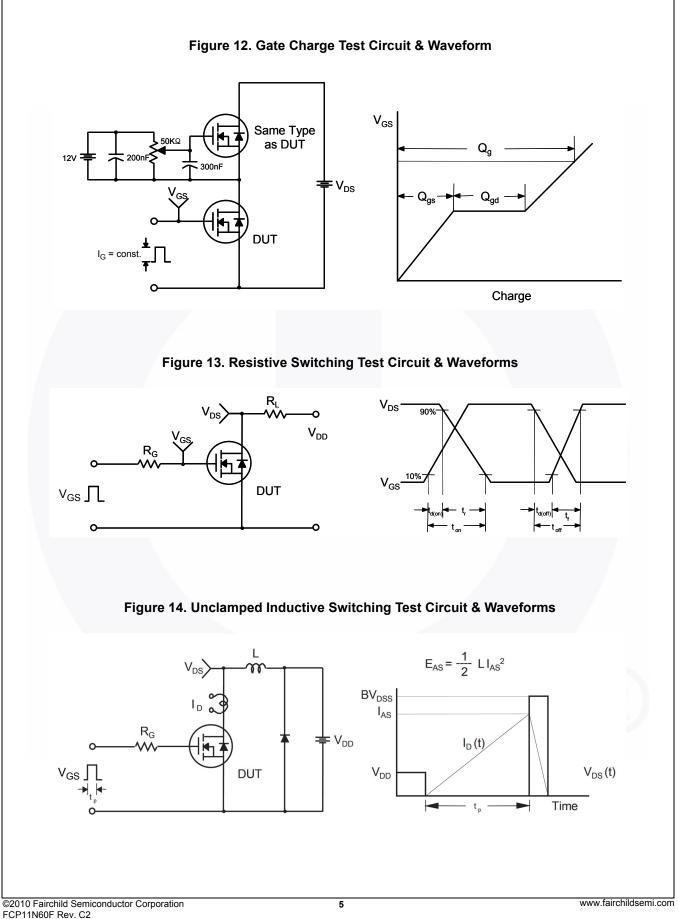


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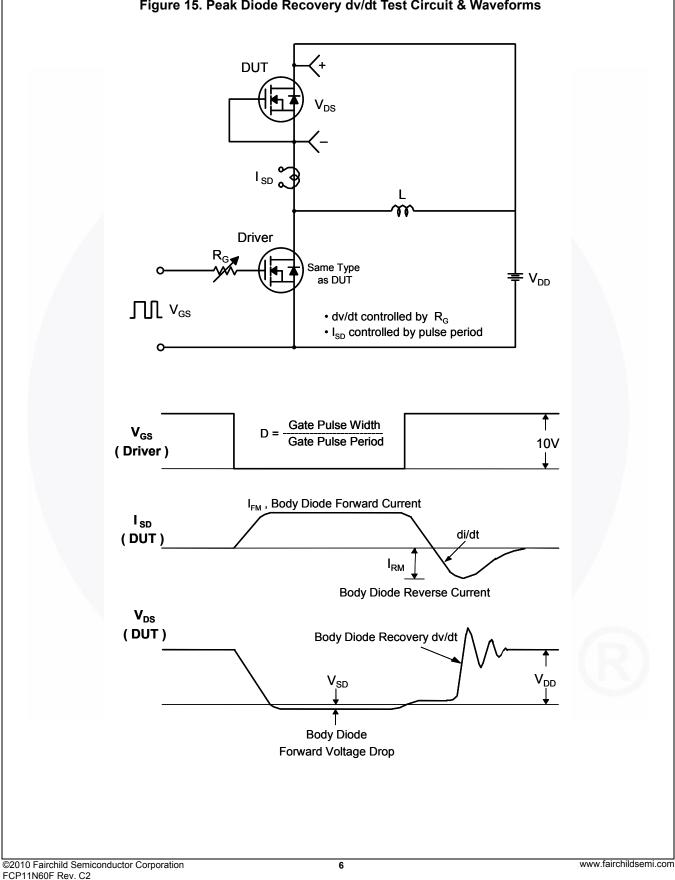
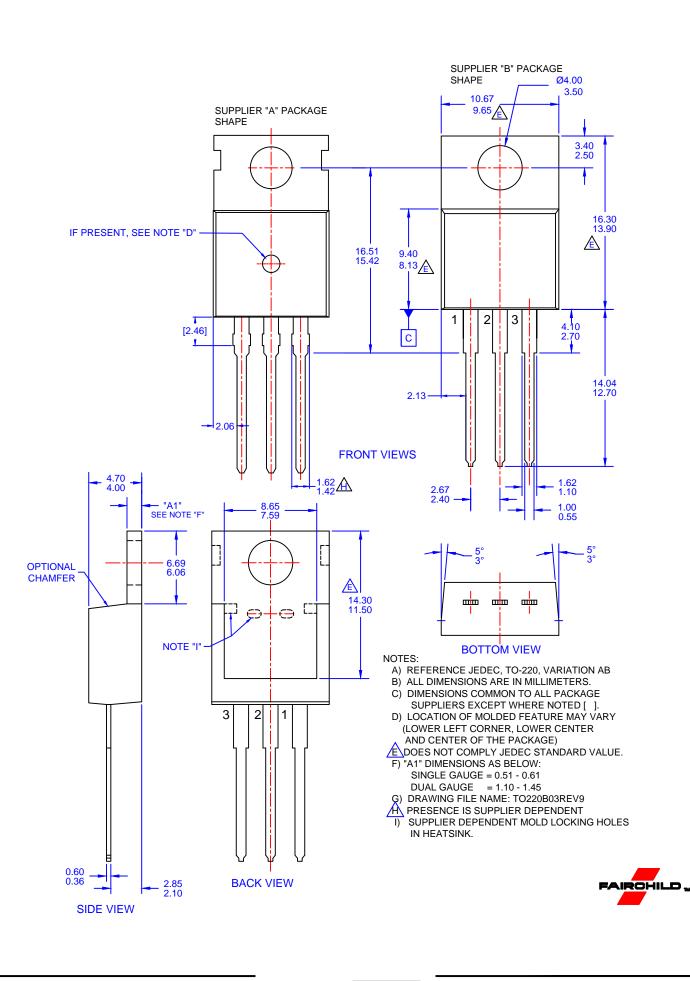


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms



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